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(12) **United States Design Patent**  
**Lin**

(10) **Patent No.:** **US D502,948 S**

(45) **Date of Patent:** **\*\* Mar. 15, 2005**

(54) **COMPUTER MAINFRAME FRONT PANEL**

D485,277 S \* 1/2004 Huang ..... D14/444

(75) **Inventor:** **Pei-Shi Lin**, Taipei Hsien (TW)

\* cited by examiner

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Taiwan Hsien (TW)

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(\*\*) **Term:** **14 Years**

(57) **CLAIM**

The ornamental design for a computer mainframe front panel, as shown and described.

(21) **Appl. No.:** **29/198,711**

**DESCRIPTION**

(22) **Filed:** **Feb. 4, 2004**

(51) **LOC (7) Cl.** ..... **14-02**

FIG. 1 is a top, front and left side perspective view of a computer mainframe front panel showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; and, FIG. 8 is a top, front and right side perspective view thereof.

(52) **U.S. Cl.** ..... **D14/444**

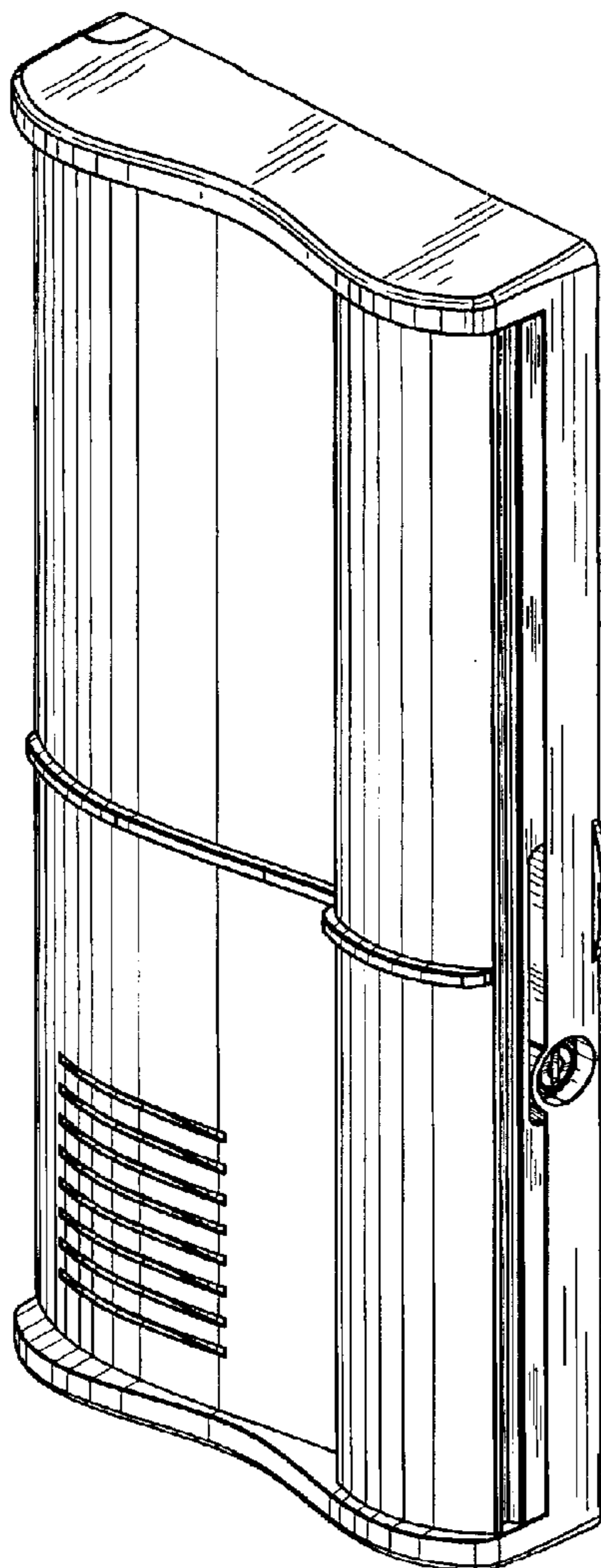
(58) **Field of Search** ..... D14/439-446,  
D14/432; D13/162, 184, 199; 312/223.2;  
361/690-696; 369/34.01, 36.01

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

D464,357 S \* 10/2002 Chien et al. .... D14/444

**1 Claim, 6 Drawing Sheets**



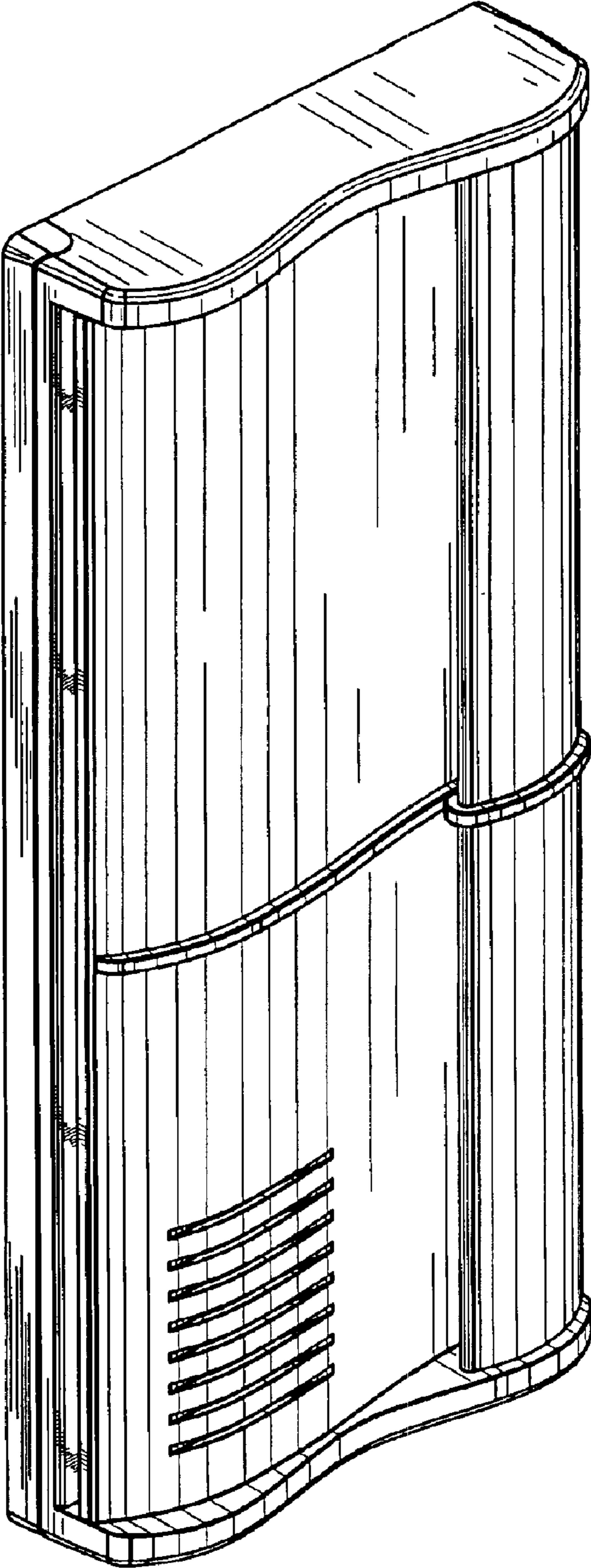


Fig. 1

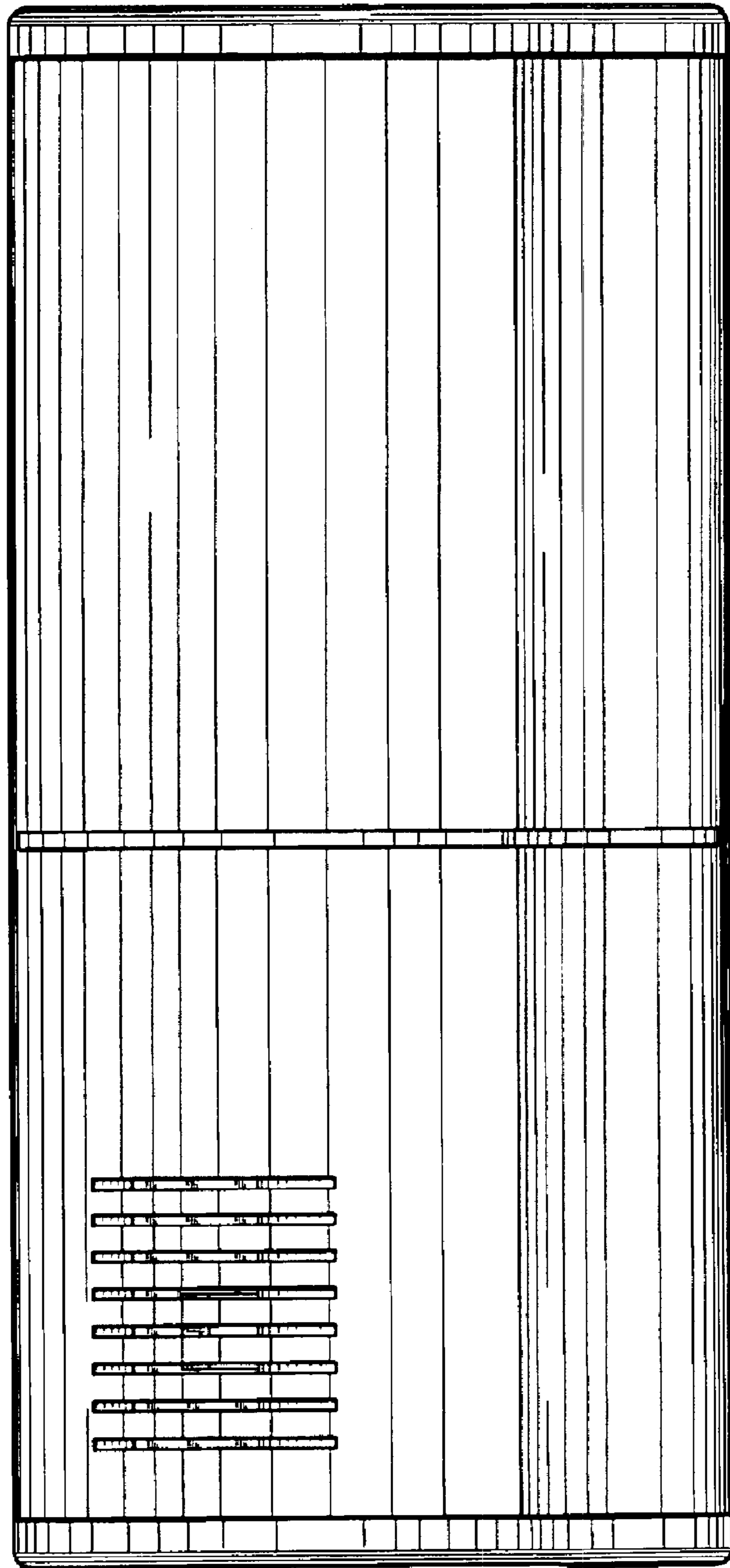


Fig. 2

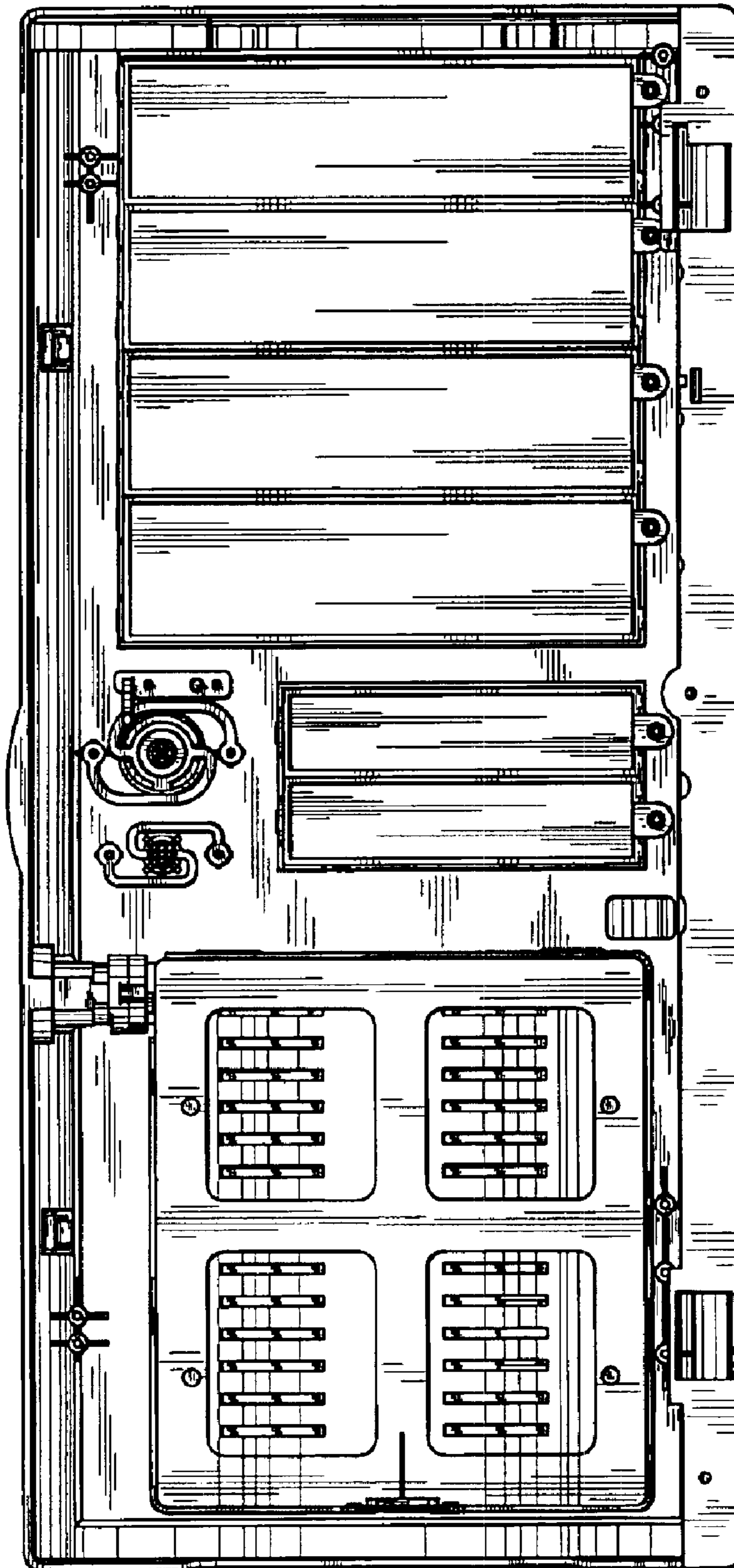


Fig. 3

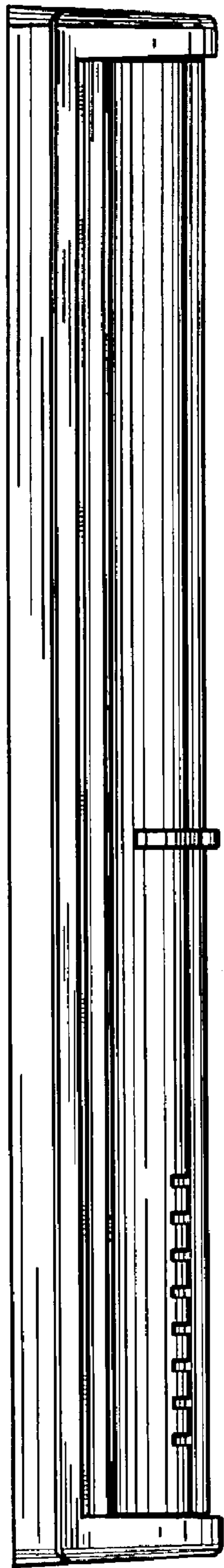


Fig. 4

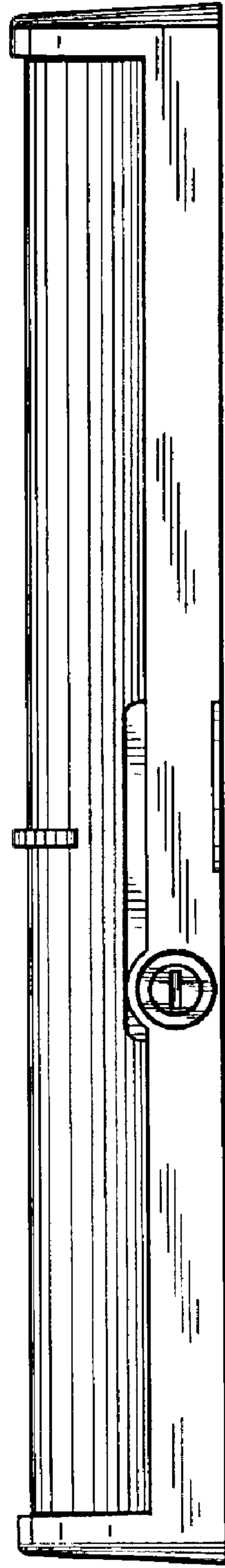


Fig. 5

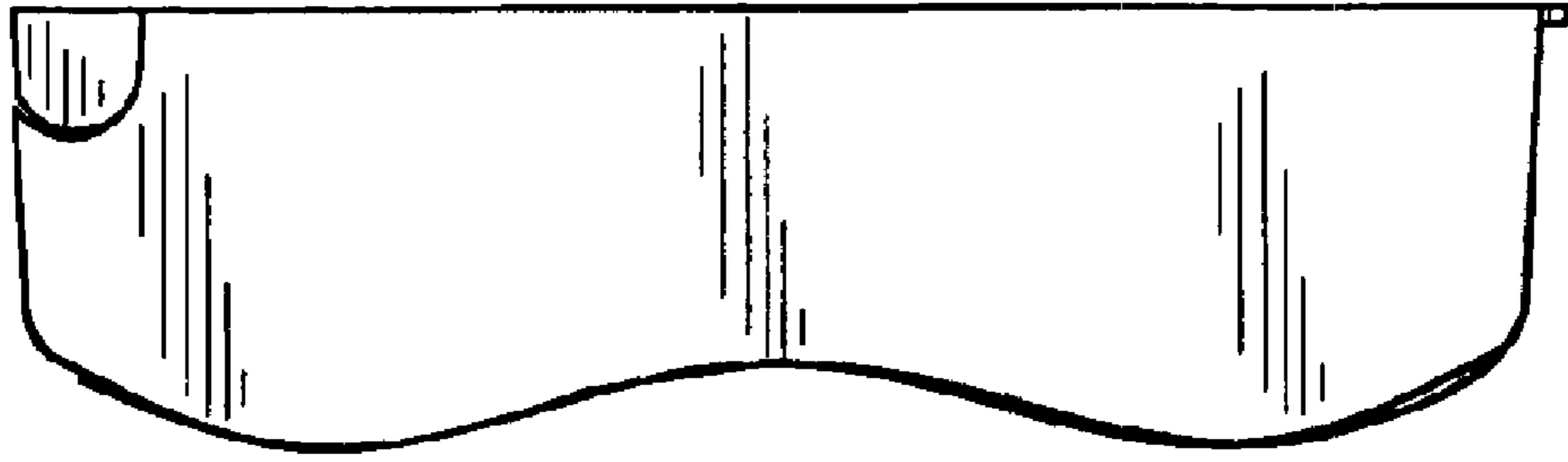


Fig. 6

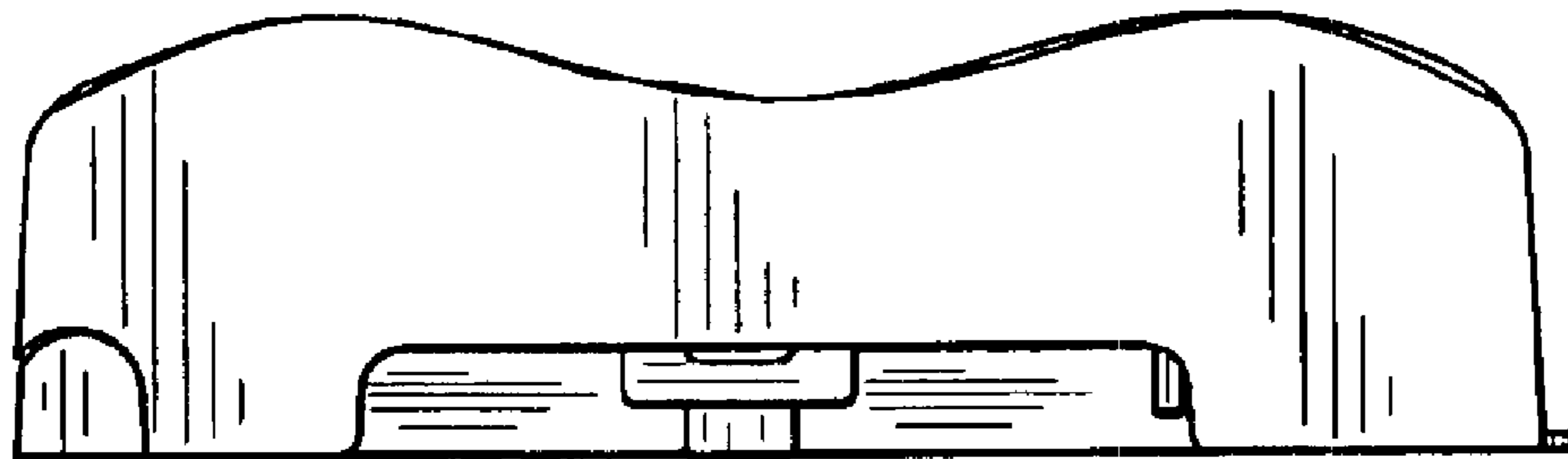


Fig. 7

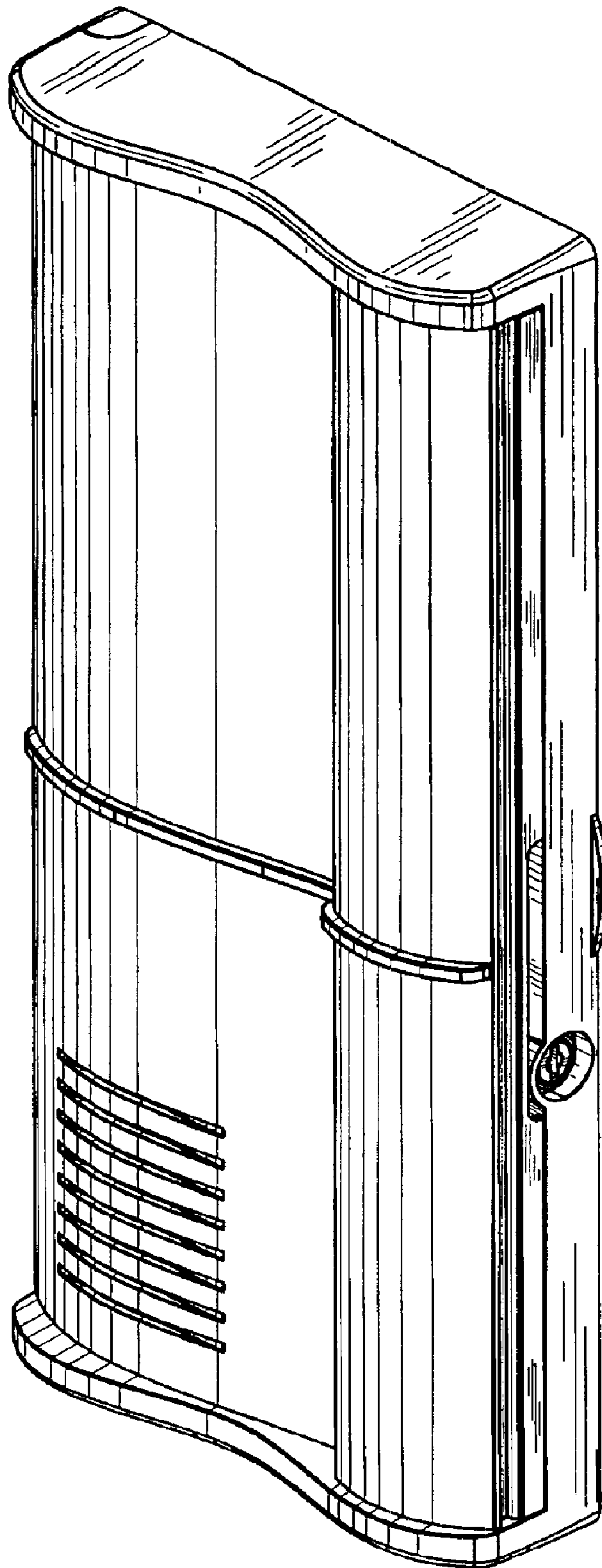


Fig. 8